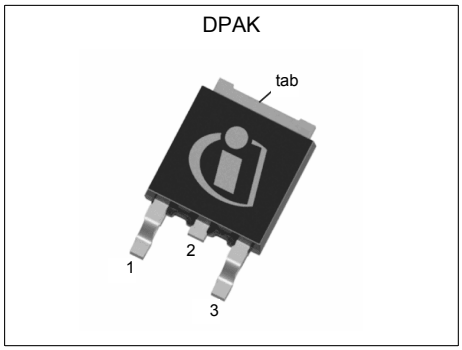
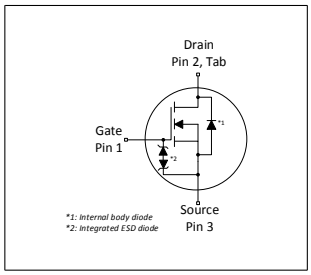
MOSFET

800V CoolMOS™ P7 Power Device

The latest 800V CoolMOS™ P7 series sets a new benchmark in 800V super junction technologies and combines best-in-class performance with state of the art ease-of-use, resulting from Infineon's over 18 years pioneering super junction technology innovation.





Features

- Best-in-class FOM $R_{DS(on)}$ * E_{oss}; reduced Q_g, C_{iss}, and C_{oss}
- Best-in-class DPAK $R_{DS(on)}$
- Best-in-class $V_{(GS)th}$ of 3V and smallest $V_{(GS)th}$ variation of ±0.5V
- Integrated Zener Diode ESD protection
- Fully optimized portfolio

Benefits

- Best-in-class performance
- Enabling higher power density designs, BOM savings and lower assembly costs
- Easy to drive and to parallel
- Better production yield by reducing ESD related failures
- Less production issues and reduced field returns
- Easy to select right parts for fine tuning of designs

Potential applications

Recommended for hard and soft switching flyback topologies for LED Lighting, low power Chargers and Adapters, Audio, AUX power and Industrial power. Also suitable for PFC stage in Consumer applications and Solar.

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or seperate totem poles is generally recommended.

Table 1 Key Performance Parameters

Parameter	Value	Unit
V_{DS} @ $T_{j=25°C}$	800	V
$R_{DS(on),max}$	2.0	Ω
$Q_{g,typ}$	9	nC
I_D	3	A
E_{oss} @ 500V	0.85	µJ
$V_{GS(th),typ}$	3	V
ESD class (HBM)	1C	-

Type / Ordering Code	Package	Marking	Related Links
IPD80R2K0P7	PG-TO252-3	80R2K0P7	see Appendix A

Table of Contents

Description 1
Maximum ratings 3
Thermal characteristics 3
Electrical characteristics 4
Electrical characteristics diagrams 6
Test Circuits 10
Package Outlines 11
Appendix A 12
Revision History 13
Trademarks 13
Disclaimer 13

1 Maximum ratings

at T_j = 25°C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current[1]	I_D	- -	- -	3 1.9	A	T_C=25°C T_C=100°C
Pulsed drain current[2]	$I_{D,pulse}$	-	-	6.0	A	T_C=25°C
Avalanche energy, single pulse	E_{AS}	-	-	6	mJ	I_D=0.4A; V_{DD}=50V
Avalanche energy, repetitive	E_{AR}	-	-	0.05	mJ	I_D=0.4A; V_{DD}=50V
Avalanche current, repetitive	I_{AR}	-	-	0.4	A	-
MOSFET dv/dt ruggedness	dv/dt	-	-	100	V/ns	V_{DS}=0 to 400V
Gate source voltage	V_{GS}	-20 -30	- -	20 30	V	static; AC (f>1 Hz)
Power dissipation	P_{tot}	-	-	24	W	T_C=25°C
Operating and storage temperature	T_j, T_{stg}	-55	-	150	°C	-
Continuous diode forward current	I_S	-	-	2.2	A	T_C=25°C
Diode pulse current[2]	$I_{S,pulse}$	-	-	6.0	A	T_C=25°C
Reverse diode dv/dt[3]	dv/dt	-	-	1	V/ns	V_{DS}=0 to 400V, I_{SD}<=0.47A, T_j=25°C
Maximum diode commutation speed[3]	di_f/dt	-	-	50	A/µs	V_{DS}=0 to 400V, I_{SD}<=0.47A, T_j=25°C

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	5.1	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	Device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	35	45	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm^2 (one layer 70µm thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling.
Soldering temperature, wave- & reflow soldering allowed	T_{sold}	-	-	260	°C	reflow MSL1

[1] Limited by $T_{j\,max}$. Maximum duty cycle D=0.5
[2] Pulse width t_p limited by $T_{j,max}$
[3] V_{DClink}=400V; $V_{DS,peak}$<$V_{(BR)DSS}$; identical low side and high side switch with identical R_G; t_{cond}<2µs

3 Electrical characteristics

at T_j = 25°C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	800	-	-	V	V_{GS}=0V, I_D=1mA
Gate threshold voltage	$V_{GS(th)}$	2.5	3	3.5	V	V_{DS}=V_{GS}, I_D=0.05mA
Zero gate voltage drain current	I_{DSS}	- -	- 10	1 -	µA	V_{DS}=800V, V_{GS}=0V, T_j=25°C V_{DS}=800V, V_{GS}=0V, T_j=150°C
Gate-source leakage curent incl. zener diode	I_{GSS}	-	-	1	µA	V_{GS}=20V, V_{DS}=0V
Drain-source on-state resistance	$R_{DS(on)}$	- -	1.7 4.4	2.0 -	Ω	V_{GS}=10V, I_D=0.94A, T_j=25°C V_{GS}=10V, I_D=0.94A, T_j=150°C
Gate resistance	R_G	-	4.0	-	Ω	f=250kHz, open drain

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	175	-	pF	V_{GS}=0V, V_{DS}=500V, f=250kHz
Output capacitance	C_{oss}	-	4.0	-	pF	V_{GS}=0V, V_{DS}=500V, f=250kHz
Effective output capacitance, energy related[1]	$C_{o(er)}$	-	7	-	pF	V_{GS}=0V, V_{DS}=0 to 500V
Effective output capacitance, time related[2]	$C_{o(tr)}$	-	61	-	pF	I_D=constant, V_{GS}=0V, V_{DS}=0 to 500V
Turn-on delay time	$t_{d(on)}$	-	10	-	ns	V_{DD}=400V, V_{GS}=13V, I_D=0.94A, R_G=33Ω
Rise time	t_r	-	8	-	ns	V_{DD}=400V, V_{GS}=13V, I_D=0.94A, R_G=33Ω
Turn-off delay time	$t_{d(off)}$	-	40	-	ns	V_{DD}=400V, V_{GS}=13V, I_D=0.94A, R_G=33Ω
Fall time	t_f	-	20	-	ns	V_{DD}=400V, V_{GS}=13V, I_D=0.94A, R_G=33Ω

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	0.6	-	nC	V_{DD}=640V, I_D=0.94A, V_{GS}=0 to 10V
Gate to drain charge	Q_{gd}	-	4	-	nC	V_{DD}=640V, I_D=0.94A, V_{GS}=0 to 10V
Gate charge total	Q_g	-	9	-	nC	V_{DD}=640V, I_D=0.94A, V_{GS}=0 to 10V
Gate plateau voltage	$V_{plateau}$	-	4.5	-	V	V_{DD}=640V, I_D=0.94A, V_{GS}=0 to 10V

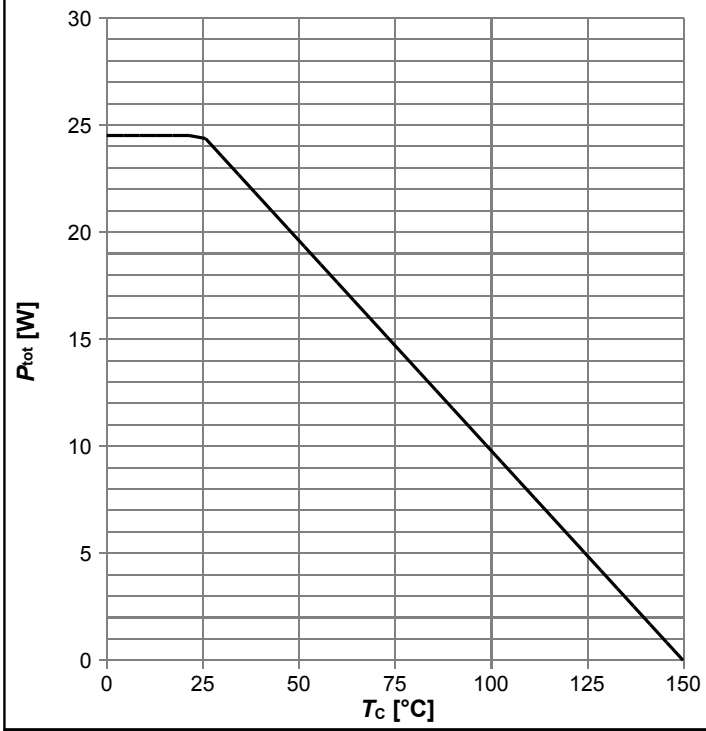
[1] $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 500V
[2] $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 500V

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	0.9	-	V	V_{GS}=0V, I_F=0.94A, T_f=25°C
Reverse recovery time	t_{rr}	-	730	-	ns	V_R=400V, I_F=0.47A, di_F/dt=50A/µs
Reverse recovery charge	Q_{rr}	-	3.0	-	µC	V_R=400V, I_F=0.47A, di_F/dt=50A/µs
Peak reverse recovery current	I_{rrm}	-	7	-	A	V_R=400V, I_F=0.47A, di_F/dt=50A/µs

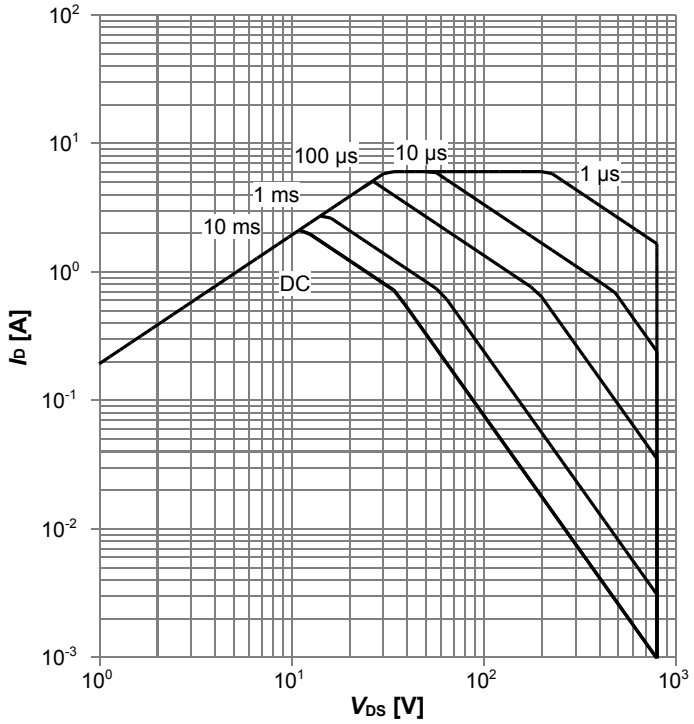
4 Electrical characteristics diagrams

Diagram 1: Power dissipation



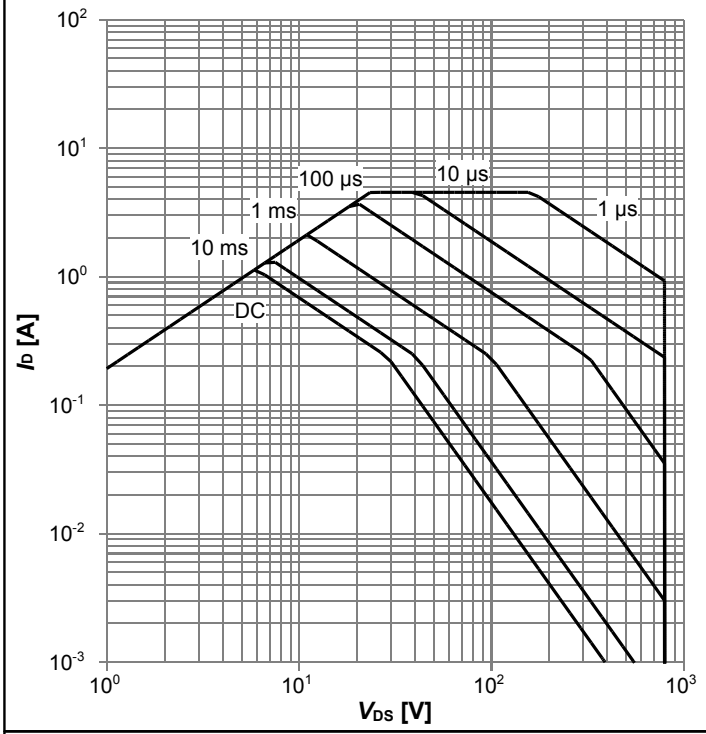
$P_{tot}=f(T_C)$

Diagram 2: Safe operating area



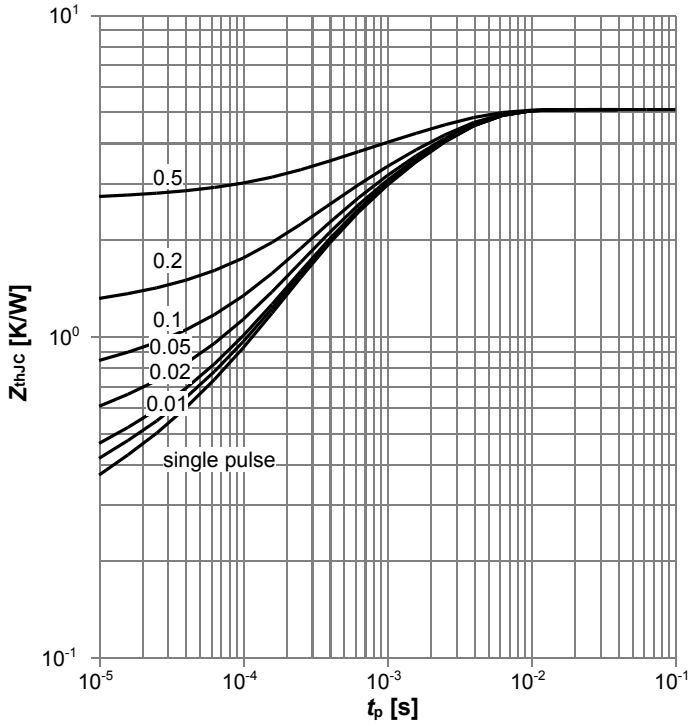
$I_D=f(V_{DS})$; $T_C=25$ °C; $D=0$; parameter: t_p

Diagram 3: Safe operating area



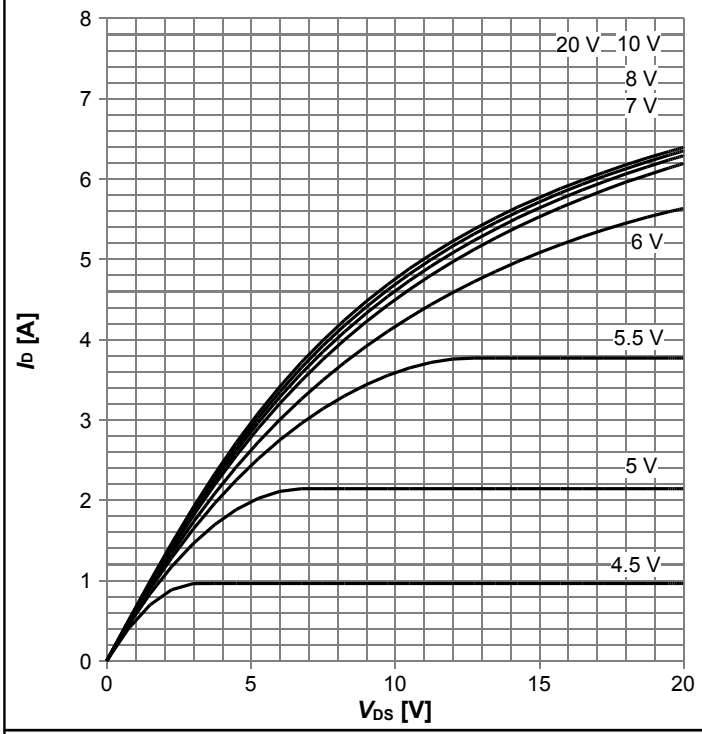
$I_D=f(V_{DS})$; $T_C=80$ °C; $D=0$; parameter: t_p

Diagram 4: Max. transient thermal impedance



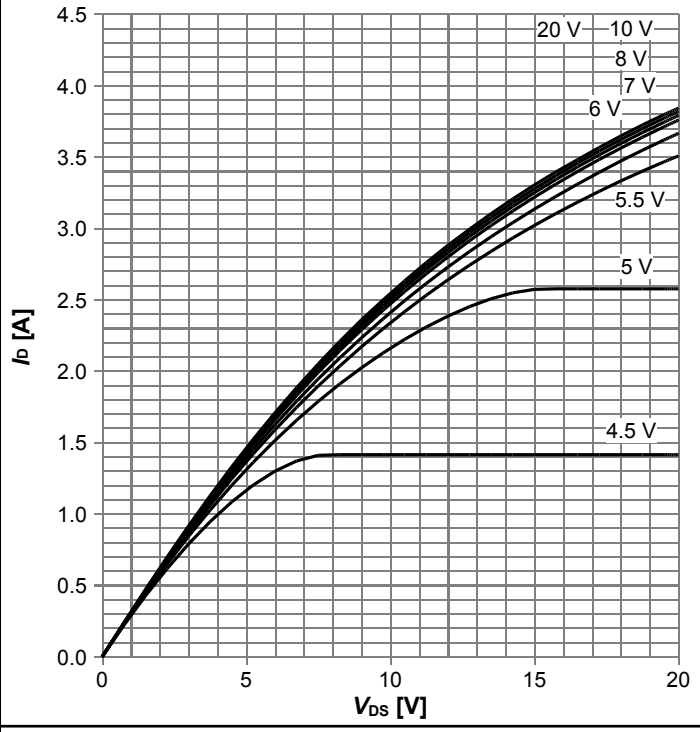
$Z_{thJC}=f(t_P)$; parameter: $D=t_p/T$

Diagram 5: Typ. output characteristics



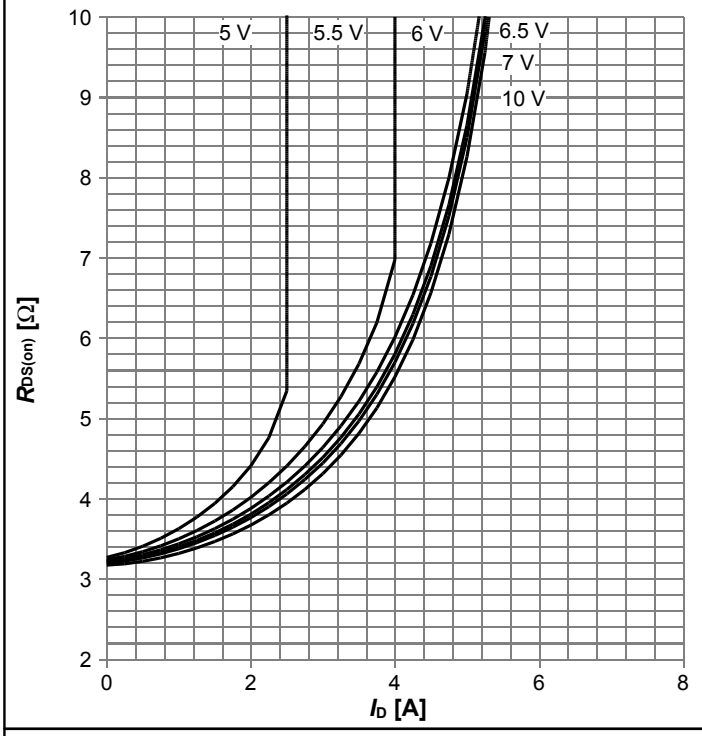
I_D=f(V_{DS}); T_j=25 °C; parameter: V_{GS}

Diagram 6: Typ. output characteristics



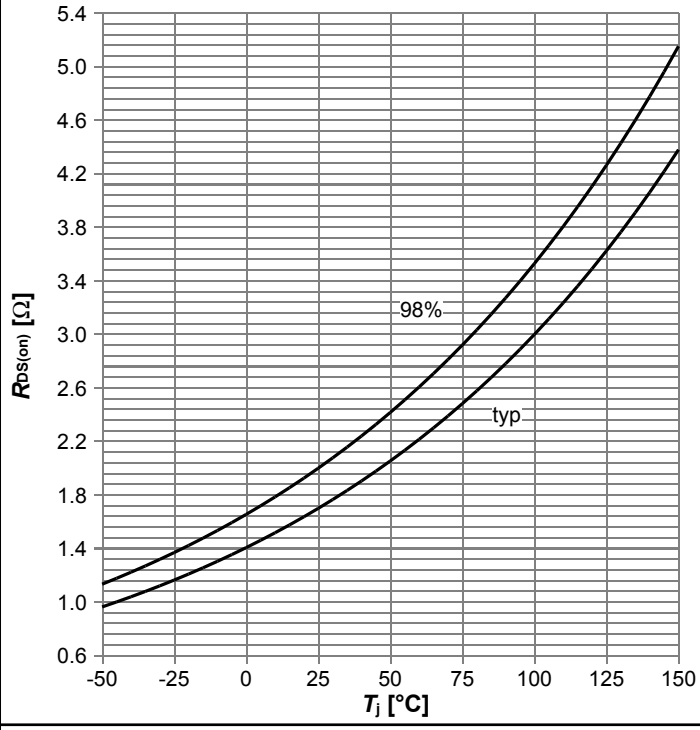
I_D=f(V_{DS}); T_j=125 °C; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



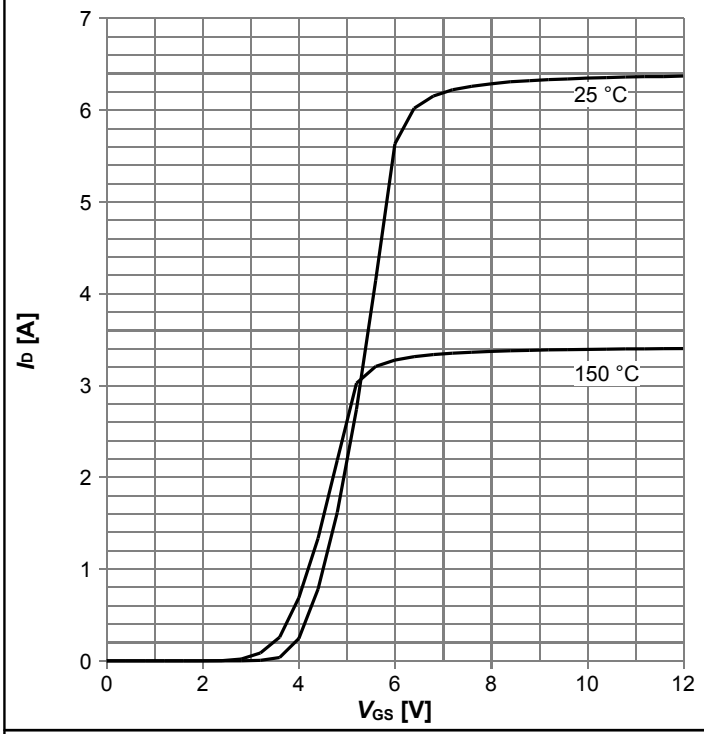
$R_{DS(on)}$=f(I_D); T_j=125 °C; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance



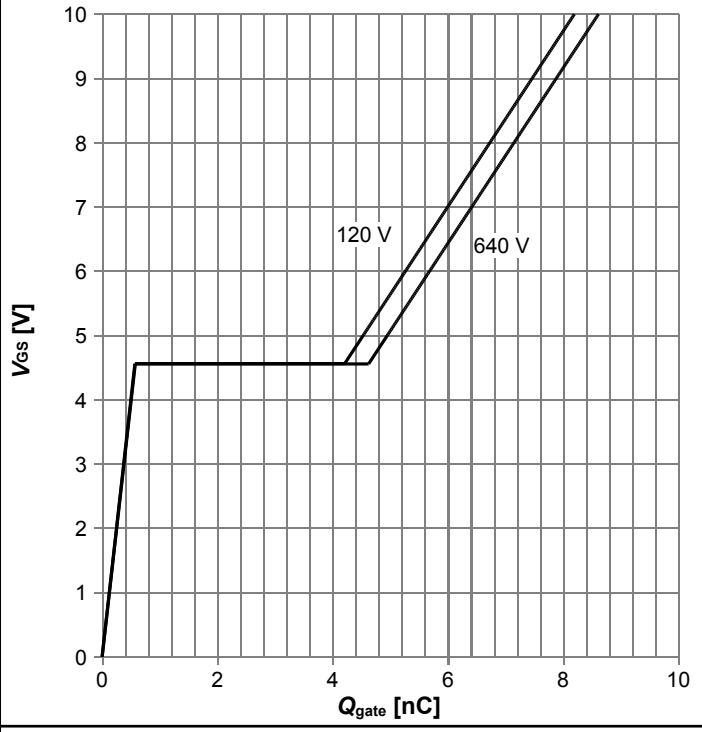
$R_{DS(on)}$=f(T_j); I_D=0.94 A; V_{GS}=10 V

Diagram 9: Typ. transfer characteristics



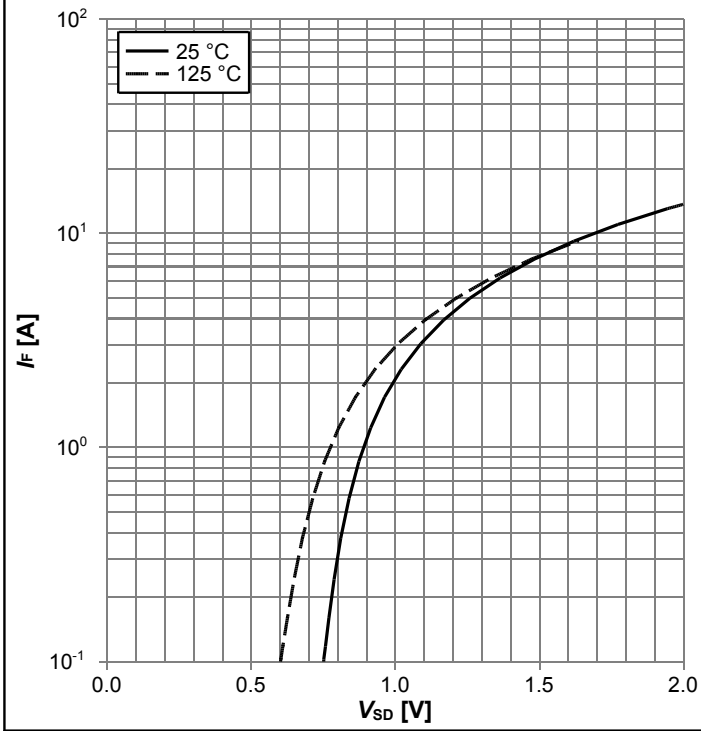
I_D=f(V_{GS}); V_{DS}=20V; parameter: T_j

Diagram 10: Typ. gate charge



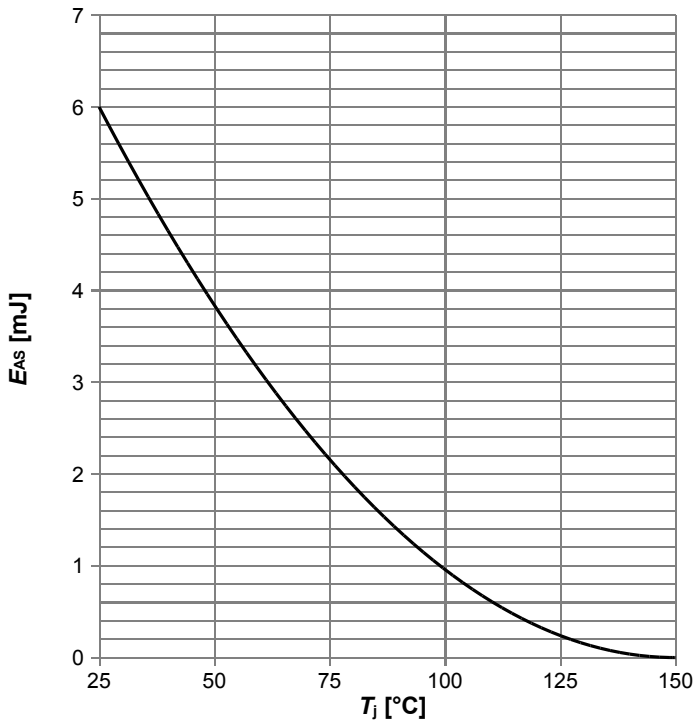
V_{GS}=f(Q_{gate}); I_D=0.94 A pulsed; parameter: V_{DD}

Diagram 11: Forward characteristics of reverse diode



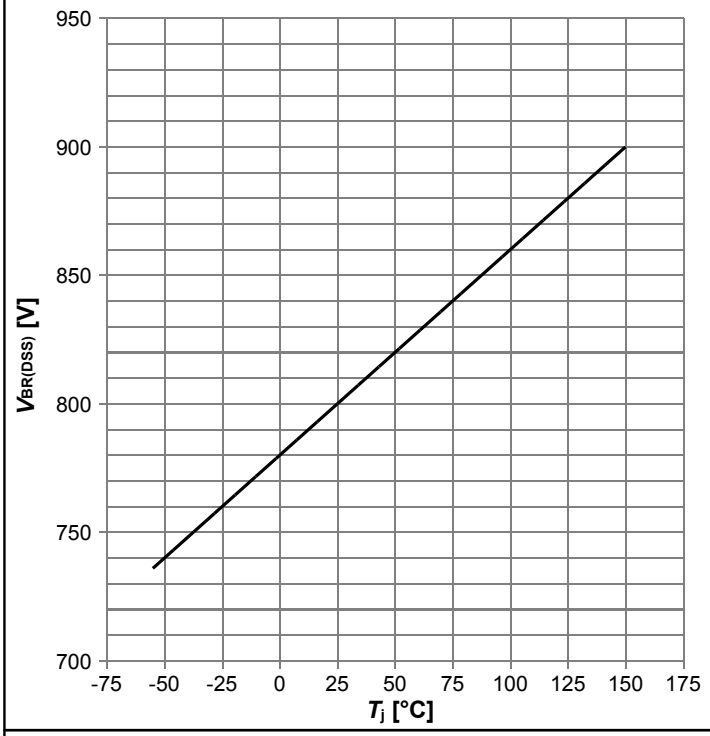
I_F=f(V_{SD}); parameter: T_j

Diagram 12: Avalanche energy



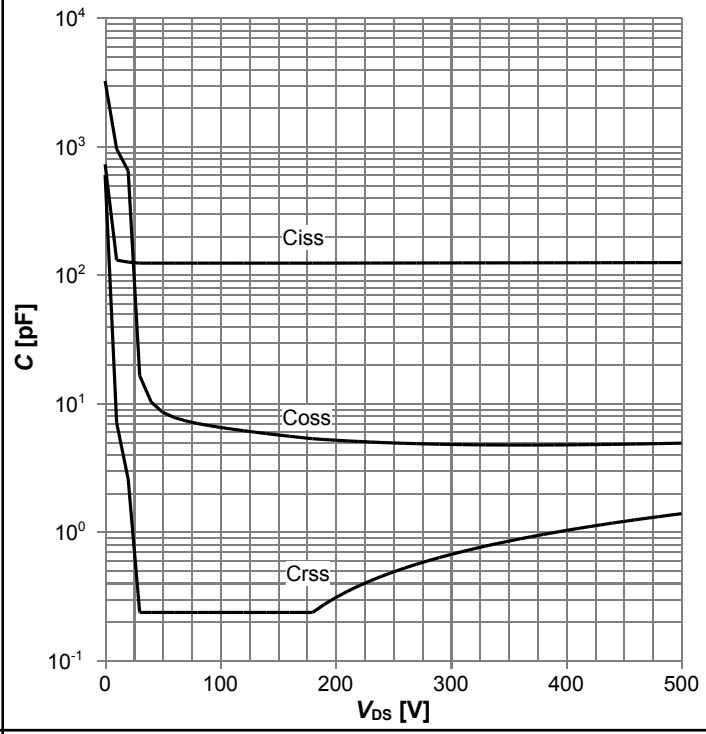
E_{AS}=f(T_j); I_D=0.4 A; V_{DD}=50 V

Diagram 13: Drain-source breakdown voltage



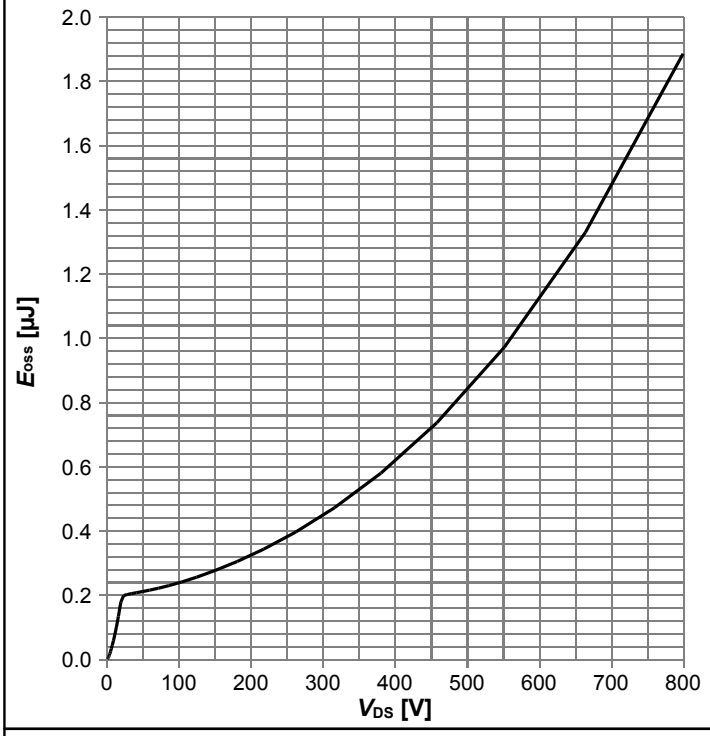
$V_{BR(DSS)}$=f(T_j); I_D=1 mA

Diagram 14: Typ. capacitances



C=f(V_{DS}); V_{GS}=0 V; f=250 kHz

Diagram 15: Typ. Coss stored energy



E_{oss}=f(V_{DS})

5 Test Circuits

Table 8 Diode characteristics

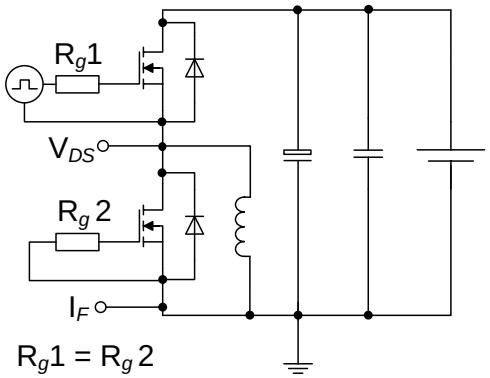
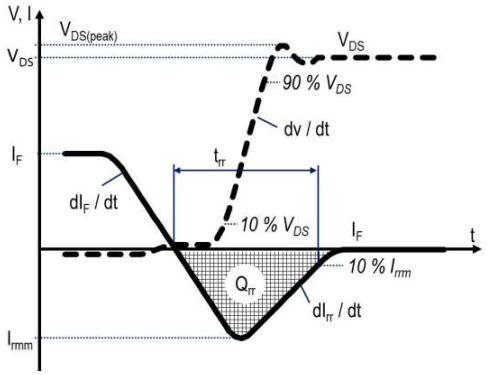
Test circuit for diode characteristics	Diode recovery waveform
	

Table 9 Switching times

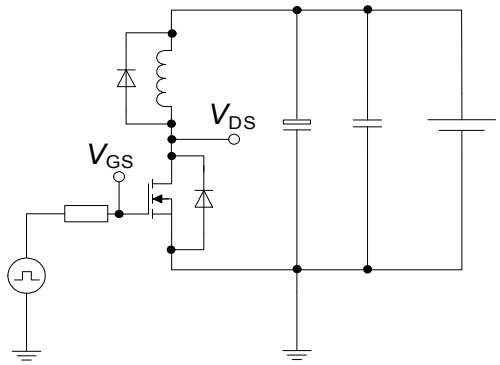
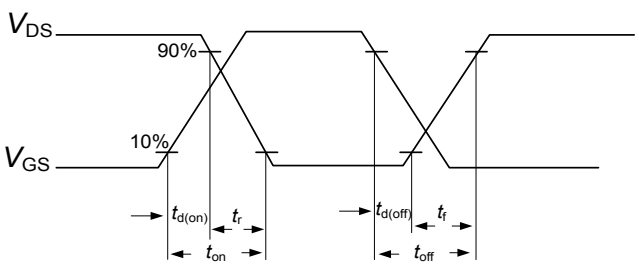
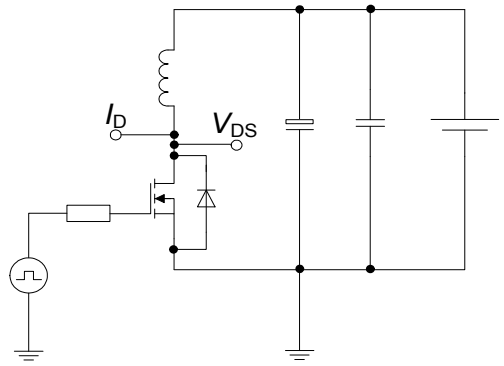
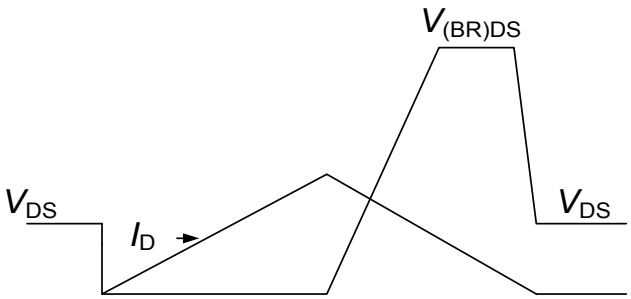
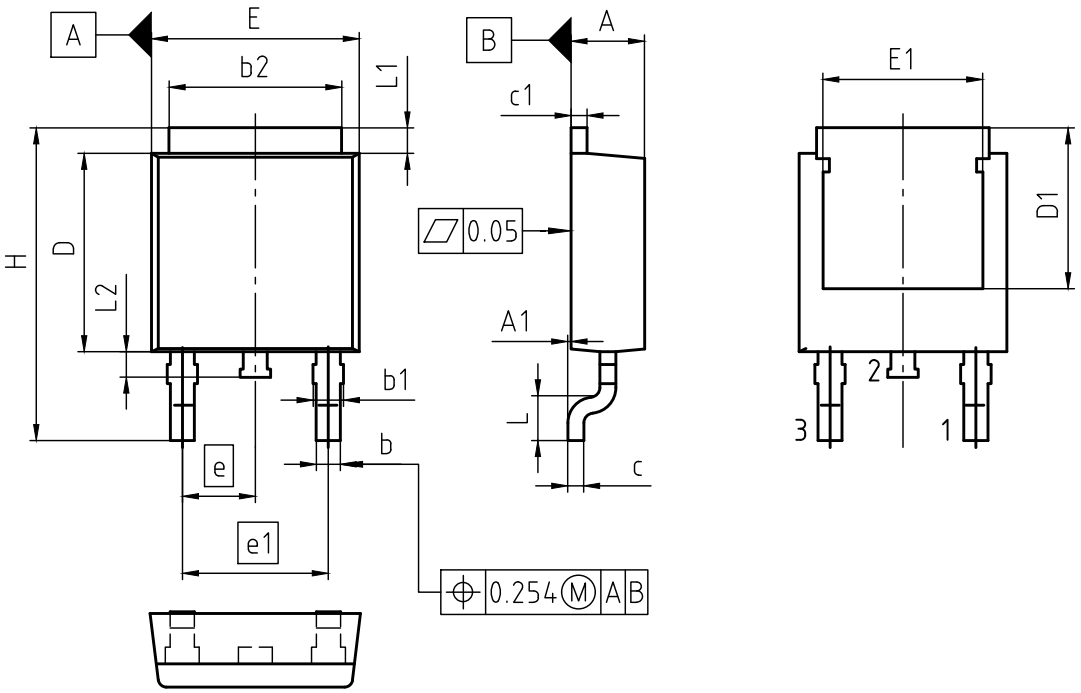
Switching times test circuit for inductive load	Switching times waveform
	

Table 10 Unclamped inductive load

Unclamped inductive load test circuit	Unclamped inductive waveform
	

6 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TO252-3-U02	
REVISION: 01	DATE: 23.11.2021	
DIMENSIONS	**MILLIMETERS**	
	MIN.	MAX.
A	2.16	2.41
A1	0.00	0.15
b	0.64	0.89
b1	0.65	1.15
b2	4.95	5.50
c	0.46	0.61
c1	0.40	0.98
D	5.97	6.22
D1	5.02	5.84
E	6.35	6.73
E1	4.32	5.50
e	2.29	
e1	4.57	
N	3	
H	9.40	10.48
L	1.18	1.78
L1	0.89	1.27
L2	0.51	1.02

ALL DIMENSIONS REFER TO JEDEC STANDARD TO-252 AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

Figure 1 Outline PG-TO252-3, dimensions in mm

7 Appendix A

Table 11 Related Links

- **IFX CoolMOS Webpage:** www.infineon.com
- **IFX Design tools:** www.infineon.com

Revision History

IPD80R2K0P7

Revision: 2022-01-12, Rev. 2.3

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2017-03-21	Release of final version
2.1	2018-02-07	Corrected front page text
2.2	2020-05-26	Updated package/symbol drawing, and product validation
2.3	2022-01-12	Updated Package Outlines

Trademarks
All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments
Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to:
erratum@infineon.com

Published by
Infineon Technologies AG
81726 München, Germany
© 2022 Infineon Technologies AG
All Rights Reserved.

Legal Disclaimer
The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics (“Beschaffenheitsgarantie”) .

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.
In addition, any information given in this document is subject to customer’s compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer’s products and any use of the product of Infineon Technologies in customer’s applications.
The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer’s technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information
For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings
Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.
The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

ENTEGRECİ

Bu belge www.entegreci.com üzerinden sunulmaktadır.

Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

www.entegreci.com | **destek@entegreci.com** | **0850 305 90 34**

Entegreci is an online electronic components store based in Türkiye. Search by manufacturer part number to see stock, prices and datasheets for integrated circuits, microcontrollers, transistors, passive components and connectors, or request a quote for parts that are not listed.

Bu sayfa Entegreci tarafından eklenmiştir. Belgenin önceki sayfaları asıl yayıncısına aittir ve içeriği değiştirilmemiştir; en güncel sürüm için belgenin yayıncısına başvurun.